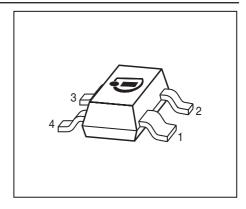


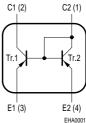
PNP Silicon Double Transistor

- To be used as a current mirror
- ullet Good thermal coupling and V_{BE} matching
- High current gain
- Low collector-emitter saturation voltage
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101









Туре	Marking	Pin Configuration				Package
BCV62A	3Js	1 = C2	2 = C1	3 = E1	4 = E2	SOT143
BCV62B	3Ks	1 = C2	2 = C1	3 = E1	4 = E2	SOT143
BCV62C	3Ls	1 = C2	2 = C1	3 = E1	4 = E2	SOT143

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V _{CEO}	30	V
(transistor T1)			
Collector-base voltage (open emitter)	V _{CBO}	30	
(transistor T1)			
Emitter-base voltage	V _{EBS}	6	
DC collector current	I _C	100	mA
Peak collector current	I _{CM}	200	
Base peak current (transistor T1)	/ _{BM}	200	
Total power dissipation, T_S = 99 °C	P _{tot}	300	mW
Junction temperature	T_{i}	150	°C
Storage temperature	$T_{\rm stg}$	-65 150	

Thermal Resistance

Junction - soldering point ¹⁾	R _{thJS}	≤170	K/W

 $^{^{1}}$ For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)



Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified

Parameter		Symbol	Values			Unit
			min.	typ.	max.	
DC Characteristics of T1		•		•	•	
Collector-emitter breakdown voltage	e	V _{(BR)CEO}	30	-	-	V
$I_{\rm C}$ = 10 mA, $I_{\rm B}$ = 0						
Collector-base breakdown voltage		V _{(BR)CBO}	30	-	-	
$I_{\rm C} = 10 \ \mu \text{A}, \ I_{\rm E} = 0$						
Emitter-base breakdown voltage		V _{(BR)EBO}	6	-	-	
$I_{\rm E} = 10 \ \mu A, I_{\rm C} = 0$						
Collector cutoff current		I _{CBO}	-	-	15	nA
$V_{\rm CB} = 30 \text{ V}, I_{\rm E} = 0$						
Collector cutoff current		I _{CBO}	-	-	5	μA
$V_{\text{CB}} = 30 \text{ V}, I_{\text{E}} = 0 , T_{\text{A}} = 150 ^{\circ}\text{C}$						
DC current gain 1)		h _{FE}	100	-	-	-
$I_{\rm C}$ = 0.1 mA, $V_{\rm CE}$ = 5 V						
DC current gain 1)		h _{FE}				
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 5 V	BCV62A		125	180	220	
	BCV62B		220	290	475	
	BCV62C		420	520	800	
Collector-emitter saturation voltage	1)	V _{CEsat}				mV
$I_{\rm C}$ = 10 mA, $I_{\rm B}$ = 0.5 mA			-	75	300	
$I_{\rm C}$ = 100 mA, $I_{\rm B}$ = 5 mA			-	250	650	
Base-emitter saturation voltage 1)		V _{BEsat}				
$I_{\rm C}$ = 10 mA, $I_{\rm B}$ = 0.5 mA			-	700	-	
$I_{\rm C}$ = 100 mA, $I_{\rm B}$ = 5 mA			-	850	-	
Base-emitter voltage 1)		V _{BE(ON)}				
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 5 V			600	650	750	
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 5 V			-		820	

¹⁾ Pulse test: $t \le 300\mu s$, D = 2%

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Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	1
DC Characteristics					•
Base-emitter forward voltage	V _{BES}				V
<i>I</i> _E = 10 μA		0.4	-	-	
$I_{\rm E}$ = 250 mA		-	-	1.8	
Matching of transistor T1 and transistor T2	I _{C1} / I _{C2}				-
at $I_{E2} = 0.5$ mA and $V_{CE1} = 5$ V		-	-	-	
<i>T</i> _A = 25 °C		0.7	-	1.3	
<i>T</i> _A = 150 °C		0.7	-	1.3	
Thermal coupling of transistor T1 and	I _{E2}	_	5	-	mA
transistor T2 ¹⁾ T1: V_{CE} = 5V					
Maximum current of thermal stability of I_{C1}					
AC characteristics of transistor T1		•			•
Transition frequency	f_{T}	-	250	-	MHz
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 5 V, f = 100 MHz					
Collector-base capacitance	C _{cb}	-	1.5	-	pF
$V_{\text{CB}} = 10 \text{ V}, f = 1 \text{ MHz}$					
Emitter-base capacitance	C _{eb}	-	8	-	
$V_{\rm EB}$ = 0.5 V, f = 1 MHz					
Noise figure	F	-	2	-	dB
$I_{\rm C}$ = 200 $\mu{\rm A},\ V_{\rm CE}$ = 5 V, $R_{\rm S}$ = 2 k Ω ,					
$f = 1 \text{ kHz}, \Delta f = 200 \text{ Hz}$					
Short-circuit input impedance	h _{11e}	-	4.5	-	kΩ
$I_{\rm C}$ = 1 mA, $V_{\rm CE}$ = 10 V, f = 1 kHz					
Open-circuit reverse voltage transf.ratio	h _{12e}	-	2	-	10-4
$I_{\rm C}$ = 1 mA, $V_{\rm CE}$ = 10 V, f = 1 kHz					
Short-circuit forward current transf.ratio	h _{21e}	100	-	900	-
$I_{\rm C}$ = 1 mA, $V_{\rm CE}$ = 10 V, f = 1 kHz					
Open-circuit output admittance	h _{22e}	-	30	-	μS
$I_{\rm C}$ = 1 mA, $V_{\rm CE}$ = 10 V, f = 1 kHz					

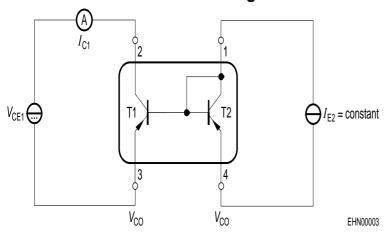
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¹⁾ Witout emitter resistor. Device mounted on alumina 15mm x 16.5mm x 0.7mm

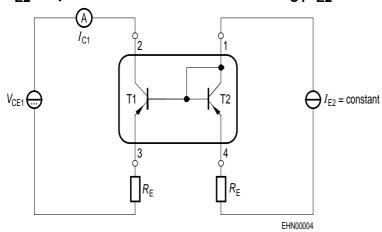


Test circuit for current matching



Note: Voltage drop at contacts: V_{CO} < 2/3 V_{T} = 16mV

Characteristic for determination of $V_{\rm CE1}$ at specified $R_{\rm E}$ range with $I_{\rm E2}$ as parameter under condition of $I_{\rm C1}/I_{\rm E2}$ = 1.3



Note: BCV62 with emitter resistors

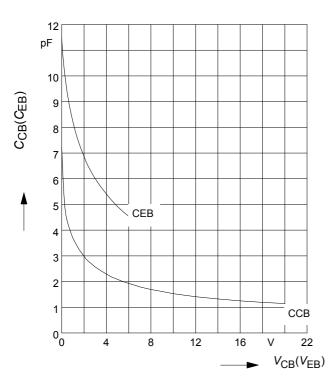
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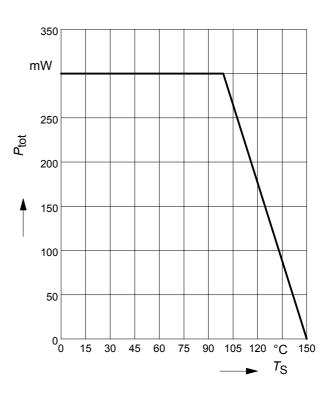
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Collector-base capacitance $C_{cb} = f(V_{CB})$ Emitter-base capacitance $C_{eb} = f(V_{EB})$

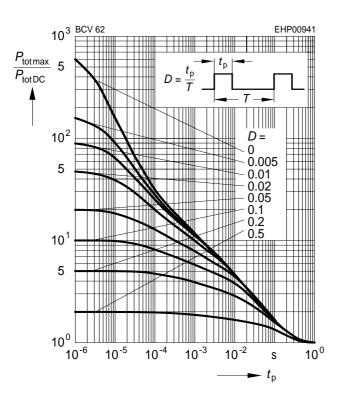
Total power dissipation $P_{tot} = f(T_S)$





Permissible pulse load

$$P_{\text{totmax}} / P_{\text{totDC}} = f(t_{p})$$

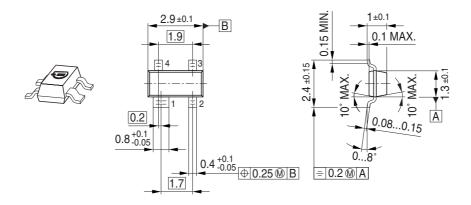


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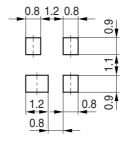
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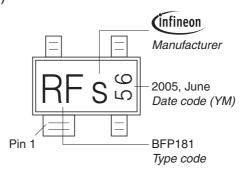
Package Outline



Foot Print

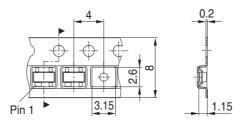


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel



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